## Features

- 5.8A, 30V, R Rsonon(Max 33m ) @ $\mathrm{V}_{\text {gs }}=-4.5 \mathrm{~V}$
- 1.4V Rated for Low Voltage Gate Drive
- SOT-23 Surface Mount for Small Footprint
- Single Pulse Avalanche Energy Rated
- Halogen-free



## General Description

This Power MOSFET is produced using Winsemi's advanced MOS technology. This latest technology has been especially designed to minimize on-state resistance, have a high rugged avalanche characteristics. This devices is specially well suited for Load switching and PA switching.


Absolute Maximum Ratings( $\mathrm{Tc}=25^{\circ} \mathrm{C}$ unless otherwise noted)

| Symbol | Parameter |  | Value | Units |
| :---: | :---: | :---: | :---: | :---: |
| Voss | Drain Source Voltage |  | 30 | V |
| ID | Continuous Drain Current |  | 5.8 | A |
| IDM | Drain Current Pulsed |  | 30 | A |
| PD | Total Power Dissipation(Note 1) | Tc= $=75^{\circ} \mathrm{C}$ | 0.25 0.3 | W |
| VGs | Gate to Source Voltage |  | $\pm 12$ | V |
| ESD | ESD Capability (Note 3) | $\mathrm{C}=100 \mathrm{pF}, \mathrm{Rs}_{\mathrm{s}}=1500 \Omega$ | 225 | V |
| $\mathrm{T}_{\mathrm{J},} \mathrm{T}_{\text {stg }}$ | Junction and Storage Temperature |  | -55~150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{L}}$ | Maximum lead Temperature for soldering purposes |  | 260 | ${ }^{\circ} \mathrm{C}$ |

Maximum ratings are those values beyond which device damage can occur.Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

Thermal Characteristics

| Symbol | Parameter | Value |  |  | Units |
| :---: | :--- | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max |  |
| $R_{\text {QJA }}$ | Thermal Resistance, Junction-to-Ambient(Note 1) | - | - | 170 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $R_{\text {QJA }}$ | Thermal Resistance, Junction-to-Ambient(Note 1) |  |  | 110 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $R_{\text {QJA }}$ | Thermal Resistance, Junction-to-Ambient(Note 2) |  |  | 300 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

Note 1: Surface-mounted on FR4 board using 1 in sq pad size (Cu area $=1.127$ in sq [1 oz] including traces)
Note 2: Surface-mounted on FR4 board using the minimum recommended pad size.
Note 3: ESD Rating Information: HBM Class 0

Electrical Characteristics ( $\mathrm{Tc}=25^{\circ} \mathrm{C}$ )

| Characteristics |  | Symbol | Test Condition | Min | Type | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Gate leakage current(Note 4) |  | Imss | $\mathrm{V}_{G S}= \pm 12 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}$ | - | - | $\pm 100$ | nA |
| Drain cut-off current(Note 4) |  | loss | $\mathrm{V}_{\mathrm{DS}}=24 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ | - | - | 1 | $\mu \mathrm{A}$ |
| Drain-source breakdown voltage |  | $V_{\text {(BR) }}$ DSS | $\mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ | 30 | - | - | V |
| Gate threshold voltage |  | $\mathrm{V}_{\mathrm{GS}(\text { (h) }}$ | $\mathrm{V}_{\text {DS }}=\mathrm{V}_{\text {GS }} \mathrm{ld}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 0.7 | 1.1 | 1.4 | V |
| Drain-source ON resistance |  | Rds(on) | $\mathrm{VGS}=4.5 \mathrm{~V}, \mathrm{ID}=5 \mathrm{~A}$ | - | 28 | 33 | $\mathrm{m} \Omega$ |
|  |  | $\mathrm{VGS}=2.5 \mathrm{~V}, \mathrm{ID}=4 \mathrm{~A}$ |  | 44 | 52 |  |
| Input capacitance |  |  | $\mathrm{C}_{\text {iss }}$ | $\begin{aligned} V_{D S} & =15 \mathrm{~V}, \\ V_{G S} & =0 \mathrm{~V}, \\ f & =1 \mathrm{MHz} \end{aligned}$ | - | 823 | 1050 | pF |
| Reverse transfer capacitance |  | $\mathrm{C}_{\text {rss }}$ | - |  | 77 | - |  |  |
| Output capacitance |  | Coss | - |  | 99 | - |  |  |
| Switching <br> time <br> (Note 5) | Turn-on Delay time | $\mathrm{t}_{\text {d(on) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{DS}}=15 \mathrm{~V}, \\ & \mathrm{R}_{\mathrm{G}}=3 \Omega, \\ & \mathrm{R}_{\mathrm{L}}=2.7 \Omega \end{aligned}$ | - | 3.3 | 5 | ns |  |
|  | Turn-on Rise time | $\mathrm{t}_{\mathrm{r}}$ |  | - | 4.8 | 7 |  |  |
|  | Turn-off Delay time | $\mathrm{t}_{\text {d(off) }}$ |  | - | 26.3 | 40 |  |  |
|  | Turn-off Fall time | $\mathrm{t}_{\mathrm{f}}$ |  | - | 4.1 | 6 |  |  |
| Total gate charge |  | Qg | $\begin{aligned} & \mathrm{V}_{\mathrm{GS}}=4.5 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{DS}}=15 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{O}}=5.8 \mathrm{~A} \end{aligned}$ | - | 9.7 | 12 | nC |  |
| Gate-source charge |  | Qgs |  | - | 1.6 | - |  |  |
| Gate-drain ("miller") Charge |  | Qgd |  | - | 3.1 | - |  |  |

Source-Drain Ratings and Characteristics ( $\mathrm{Ta}=25^{\circ} \mathrm{C}$ )

| Characteristics | Symbol | Test Condition | Min | Type | Max | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Continuous drain reverse current | $\mathrm{I}_{\mathrm{DR}}$ | - | - | - | 5.8 | A |
| Pulse drain reverse current | $\mathrm{I}_{\mathrm{DRP}}$ | - | - | - | 30 | A |
| Forward voltage (diode) | $\mathrm{V}_{\mathrm{DSF}}$ | $\mathrm{I}_{\mathrm{DR}}=1 \mathrm{~A}, \mathrm{~V}$ GS $=0 \mathrm{~V}$ | - | 0.71 | 1.0 | V |

Note 4: Pulse Test: Pulse Width $\leq 300 \mu \mathrm{~s}$, Duty Cycle 3 2\%.
Note 5: Switching characteristics are independent of operating junction temperature.
This transistor is an electrostatic sensitive device
Please handle with caution


Fig 1: On-Region Characteristics


Figure 3: On-Resistance vs. Drain Current and Gate Voltage


Figure 5: On-Resistance vs. Gate-Source Voltage


Figure 2: Transfer Characteristics


Figure 4: On-Resistance vs. Junction
Temperature

Figure 6: Body-Diode Characteristics


Figure 7: Gate-Charge Characteristics


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)


Figure 8: Capacitance Characteristics


Figure 10: Single Pulse Power Rating Junction-toAmbient (Note E)


Figure 11: Normalized Maximum Transient Thermal Impedance

WFY5N03

SOT-23 Package Dimension

| DIM | MILLIMTERS |  | INCHES |  |
| :--- | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN |  |
| A | 0.95 |  | 0.037 |  |
| A1 | 1.90 |  | 0.074 |  |
| B | 2.60 | 3.00 | 0.055 | 0.118 |
| C | 1.40 | 1.70 | 0.110 | 0.122 |
| D | 2.80 | 3.10 | 0.039 | 0.051 |
| E | 1.00 | 1.30 | 0.000 | 0.004 |
| F | 0.00 | 0.10 | 0.014 | 0.020 |
| G | 0.35 | 0.50 | 0.004 | 0.008 |
| H | 0.10 | 0.20 | 0.012 | 0.024 |
| I | 0.30 | 0.60 | $50^{\circ}$ | $10^{\circ}$ |
| J | $50^{\circ}$ | $10^{\circ}$ |  |  |



